AFBR-57G5MZ

32GFC SFP**28** for Multi-Mode Optical Fiber
Digital Diagnostic SFP, 850nm, 32G/16G/8G Low Voltage (3.3V)
Fibre Channel Optical Transceiver

Data Sheet

Description

Avago Technologies' AFBR-57G5MZ optical transceiver supports high speed serial links over multi-mode optical fiber at signalling rates up to 28.05Gb/s (the serial line rate of 32GFC). The product is compliant with Small Form Plug-gable industry agreements SFP and SFP28 for mechanical and low speed electrical specifications. High speed elec-trical and optical specifications are compliant with ANSI Fibre Channel FC-PI-6.

The AFBR-57G5MZ is a multi-rate 850nm transceiver which ensures compliance with FC-PI-6 32GFC, 16GFC and 8GFC specifications. Per the requirements of 32GFC, internal clock and data recovery circuits (CDRs) are present on both electrical input and electrical output of this transceiver. These CDRs will lock at 28.05Gb/s and 14.025Gb/s (32GFC and 16GFC) but must be bypassed for operation at 8.5Gb/s (8GFC), accomplished by using two Rate Select inputs to configure transmit and receive sides. Transmitter and receiver can operate at different data rates, as is often seen during Fibre Channel speed negotiation.

Digital diagnostic monitoring information (DMI) is present in the AFBR-57G5MZ per the requirements of SFF-8472, providing real time monitoring information of transceiver laser, receiver and environment conditions over a SFF-8419 2-wire serial interface.

Related Products

- AFCT-57G5MZ: 1310nm SFP for 32G/16G/8G Fibre Channel
- AFBR-57F5MZ: 850nm SFP for 16G/8G/4G Fibre Channel
- AFCT-57F5AMZ: 1310nm SFP for 16G/8G/4G Fibre Channel
- AFBR-57D9AMZ: 850nm SFP for 8G/4G/2G Fibre Channel
- AFCT-57D5ATPZ: 1310nm SFP for 8G/4G/2G Fibre Channel
- AFCT-57D5ANPZ: 1310nm SFP for 8G/4G/2G Fibre Channel
- AFBR-57R5APZ: 850nm SFP for 4G/2G/1G Fibre Channel
- AFCT-57R5APZ: 1310nm SFP for 4G/2G/1G Fibre Channel
- AFCT-57R5ATPZ: 1310nm SFP for 4G/2G/1G Fibre Channel
- AFCT-57R5ANPZ: 1310nm SFP for 4G/2G/1G Fibre Channel

Features

- Compliant to RoHS directives
- 850nm Vertical Cavity Surface Emitting Laser (VCSEL)
- Class 1 eye safe per IEC60825-1 and CDRH
- Wide temperature range (0°C to 70°C)
- LC duplex connector optical interface conforming to ANSI TIA/EIA604-10 (FOCIS 10A)
- Diagnostic features per SFF-8472 "Diagnostic Monitoring Interface for Optical Transceivers"
- Real time monitoring of:
  - Transmitter average optical power
  - Received average optical power
  - Laser bias current
  - Temperature
  - Supply Voltage
- SFP28 mechanical specifications per SFF-8432
- SFP28 compliant low speed interface per SFF-8419
- Fibre Channel FC-PI-6 compliant high speed interface
  - 3200-M5-SN-S, 1600-M5-SN-S, 800-M5-SN-S
  - 3200-M5E-SN-I, 1600-M5E-SN-I, 800-M5E-SN-I
  - 3200-M5F-SN-I, 1600-M5F-SN-I, 800-M5F-SN-I
- Fibre Channel FC-PI-6 compliant optical link distances

Applications

- Fibre Channel switches (director, stand alone, blade)
- Fibre Channel Host Bus Adapters
- Fibre Channel RAID controllers
- Fibre Channel tape drive
- Port side connections
- Inter-switch or inter-chassis aggregated links

Patent - www.avagotech.com/patents

Transmitter Section

The transmitter section includes a Transmitter Optical SubAssembly (TOSA), laser driver circuit, Clock and Data Recovery circuit (CDR) and an electrical input stage with variable equalization controls. The TOSA contains a 850nm Vertical Cavity Surface Emitting Laser (VCSEL) light source with integral light monitoring function and imaging optics to assure efficient optical coupling to the LC connector in-terface. The TOSA is driven by a laser driver IC, which uses the differential output from an integral Tx CDR stage to modulate and regulate VCSEL optical power. As mandated by FC-PI-6, the integral CDR cleans up any incoming jit-ter accumulated from the host ASIC, PCB traces and SFP electrical connector. Between the SFP electrical connector and Tx CDR is a variable, i2c controlled, equalization cir-cuit to optimize SFP performance with non-ideal incom-ing electrical waveforms. Note the Tx CDR is engaged with Tx_RATE=high (32GFC) and auto-configured (engaged or bypassed) with Tx_RATE=low (16G/8G).

Receiver Section:

The receiver section includes a Receiver Optical SubAssembly (ROSA), pre-amplification and post-amplification circuit, Clock and Data Recovery Circuit and an electrical output stage with variable emphasis controls. The ROSA, containing a high speed PIN detector, pre-amplifier and imaging optics efficiently couple light from the LC connector interface and perform an optical to electrical conversion. The resulting differential electrical signal passes through a post amplification circuit and into a Clock and Data Recovery circuit (CDR) for cleaning up accumulated jitter. Note the Rx CDR is engaged with Rx_RATE=high (32GFC) and auto-configured (engaged or bypassed) with Rx_RATE=low (16G/8G).

Digital Diagnostics:

The AFBR-57G5MZ is compliant to the Diagnostic Monitoring Interface (DMI) defined i n document SFF-8472. These features allow the host to access, via i2c, real time diagnostic monitors of transmit optical power, received optical power, temperature, supply voltage and laser operating current.

Low Speed Interfaces:

Conventional low speed interface I/Os are available as defined in documents SFF-8419 t o man age coarse and fine functions of the optical transceiver. On the transmit side, a Tx_DISABLE input is provided for the host to turn on and off the outgoing optical signal. A transmitter rate select control input, Tx_RATE, is provided to configure the transmitter stages for 32GFC, 16GFC or 8GFC operation (logic HIGH reserved for 32GFC, logic LOW reserved for 16GFC and 8GFC). A transmitter fault indicator output, Tx_FAULT, is available for the SFP to signal a host of a transmitter operational problem. A receiver rate select control input, Rx_RATE, is provided to configure receiver stages for 32GFC, 16GFC, or 8GFC operation (logic HIGH reserved for 32GFC, logic LOW reserved for 16GFC and 8GFC). A received optical power loss of signal indicator, RX_LOS, is available to advise the host of a receiver operational problem.

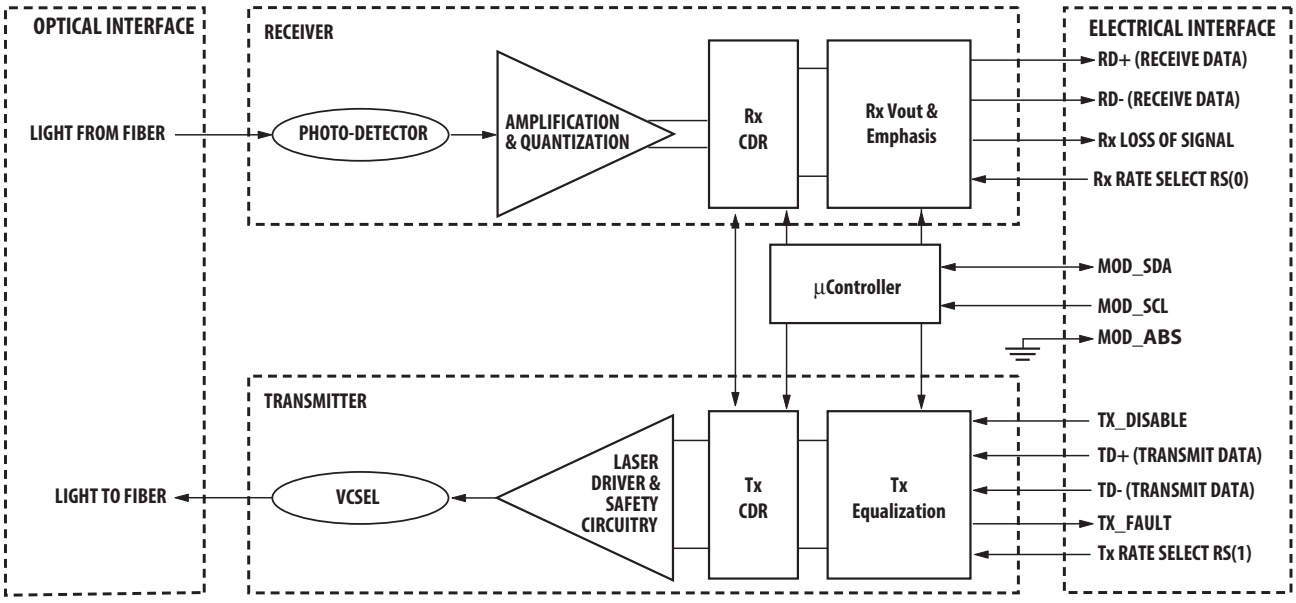


Figure 1. Transceiver functional diagram.

Table 1. Regulatory Compliance

Feature	Test Method	Performance
Electrostatic Discharge (ESD) to the Electrical Contacts	JEDEC Human Body Model (HBM) (JESD22-A114-B)	High speed contacts shall withstand 1000V. All other contacts shall withstand 2000 V.
Electrostatic Discharge (ESD) to the Optical Connector Receptacle	EN61000-4-2, Criterion B	When installed in a properly grounded housing and chassis the units are subjected to 15kV air discharges during operation and 8kV direct discharges to the case.
Electromagnetic Interference (EMI)	FCC Part 15 CENELEC EN55022 (CISPR 22A) VCCI Class 1	System margins are dependent on customer board and chassis design.
Immunity	Variation of IEC 61000-4-3	Typically shows no measurable effect from a 10V/m field swept from 80 MHz to 1 GHz applied to the module without a chassis enclosure
Laser Eye Safety and Equipment Type Testing TÜV Rheinland Product Safety | BAUART GEPRÜFT | TYPE APPROVED	US FDA CDRH AEL Class 1 US21 CFP, Subchapter J per Paragraphs 1002.10 and 1002.12 (IEC) EN60825-1:1994 +A11 +A2 (IEC) EN60825-2:1994 +A1 (IEC) EN60950:1992 +A1 +A2 +A3 +A4 +A11	CDRH Certification 9720151-155 TUV File: R72121699
Component Recognition	Underwriters Laboratories (UL) and Canadian Standards Association (CSA) Joint Component Recognition for Information Technology Equipment including Electrical Business Equipment	UL File: E173874
RoHS Compliance		Less than 1000 ppm of cadmium, lead, mercury, hexavalent chromium, polybrominated biphenyls (PPB) and polybrominated biphenyl ethers (PBDE).

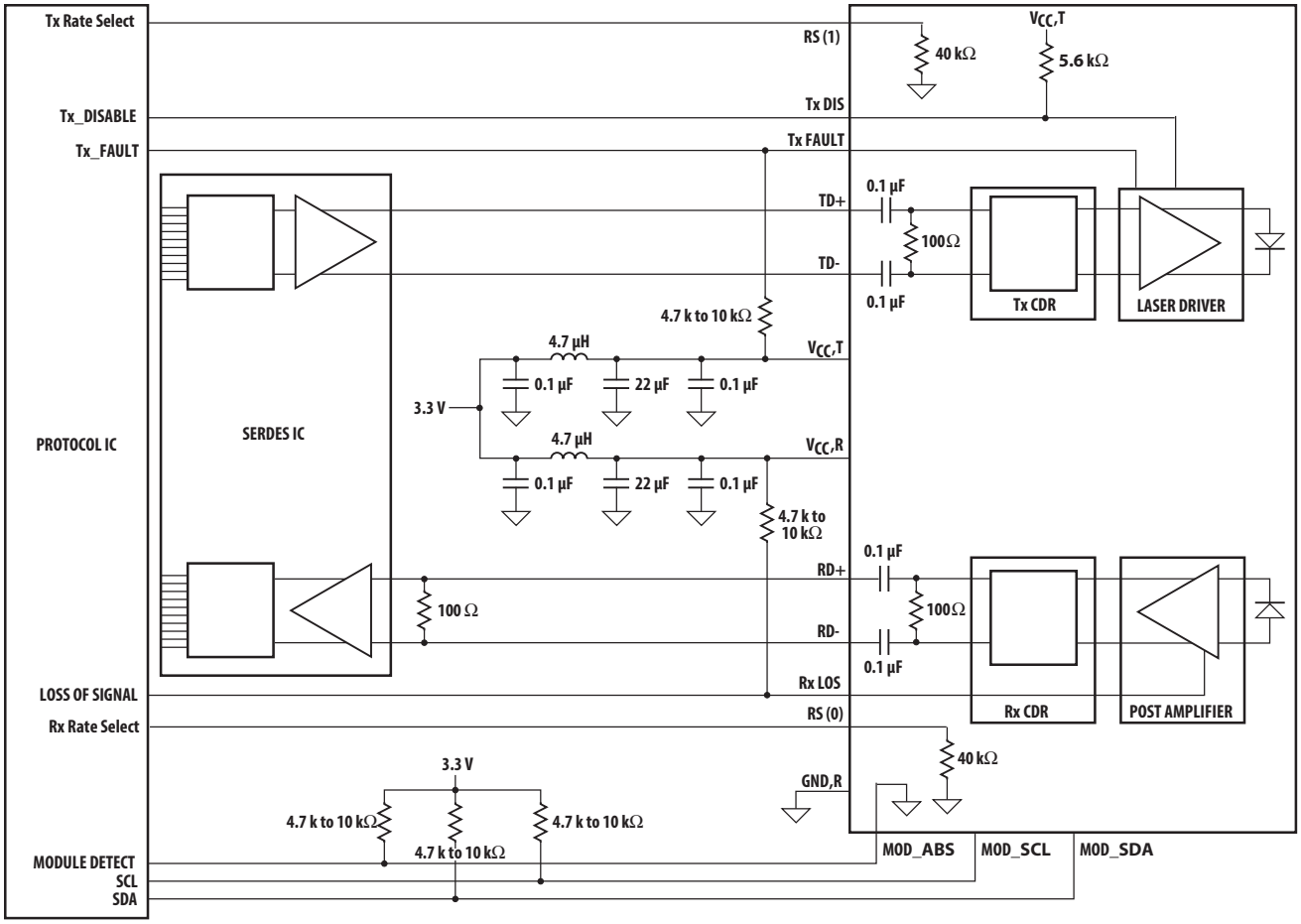
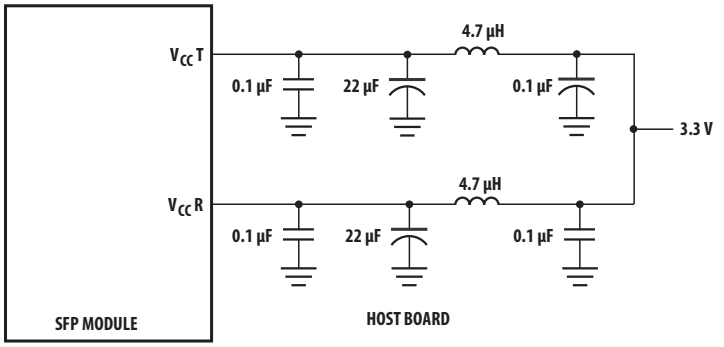


Figure 2. Typical application configuration



NOTE: INDUCTORS MUST HAVE LESS THAN 0.5Ω SERIES RESISTANCE TO LIMIT VOLTAGE DROP TO THE SFP MODULE.

Figure 3. Recommended power supply filter

Table 2. Pin Description

Pin	Name	Function/Description	Notes
1	VeeT	Transmitter Ground	
2	TX_FAULT	Transmitter Fault Indication – High indicates a fault condition	Note 1
3	TX_DISABLE	Transmitter Disable – Module optical output disables on high or open	Note 2
4	MOD_SDA	Module Definition 2 – Two wire serial ID interface data line (SDA)	Note 3
5	MOD_SCL	Module Definition 1 – Two wire serial ID interface clock line (SCL)	Note 3
6	MOD_ABS	Module Definition 0 – Grounded in module (module present indicator)	Note 3
7	Rx Rate Select, RS(0)	Receiver Rate Select. Logic High = 28.05Gb/s, Logic Low = 14.025Gb/s and 8.5Gb/s	Note 8
8	RX_LOS	Loss of Signal – High indicates loss of received optical signal	Note 4
9	Tx Rate Select, RS(1)	Transmitter Rate Select. Logic High = 28.05Gb/s, Logic Low = 14.025Gb/s and 8.5Gb/s	Note 8
10	VeeR	Receiver Ground	
11	VeeR	Receiver Ground	
12	RD-	Inverse Received Data Out	Note 5
13	RD+	Received Data Out	Note 5
14	VeeR	Receiver Ground	
15	VccR	Receiver Power + 3.3 V	Note 6
16	VccT	Transmitter Power + 3.3 V	Note 6
17	VeeT	Transmitter Ground	
18	TD+	Transmitter Data In	Note 7
19	TD-	Inverse Transmitter Data In	Note 7
20	VeeT	Transmitter Ground	

Notes:

1. TX_FAULT is an open collector/drain output, which must be pulled up with a 4.7k – 10kΩ resistor on the host board. When high, this output indi-cates a laser fault of some kind. Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.
2. TX_DISABLE is an input that is used to shut down the transmitter optical output. It is internally pulled up (within the transceiver) with a 5.6 kΩ resistor.

   Low (0 – 0.8V): Transmitter on
   Between (0.8V and 2.0V): Undefined
   High (2.0 – Vcc max) or OPEN: Transmitter Disabled

3. The signals Mod_ABS, SCL, SDA designate the two wire serial interface pins. They must be pulled up with a 4.7k – 10kΩ resistor on the host board.
   Mod_ABS is grounded by the module to indicate the module is present
   Mod_SCL is serial clock line (SCL) of two wire serial interface
   Mod_SDA is serial data line (SDA) of two wire serial interface
4. RX_LOS (Rx Loss of Signal) is an open collector/drain output that must be pulled up with a 4.7k – 10kΩ resistor on the host board. When high, this output indicates the received optical power is below the worst case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.
5. RD-/+ designate the differential receiver outputs. They are AC coupled 100Ω differential lines which should be terminated with 100Ω differential at the host SERDES input. AC coupling is done inside the transceiver and is not required on the host board. The voltage swing on these lines will be between 50 and 900 mV differential (25 – 450 mV single ended) when properly terminated.
6. VccR and VccT are the receiver and transmitter power supplies. See SFF-8419 for the details.
7. TD-/+ designate the differential transmitter inputs. They are AC coupled differential lines with 100Ω differential termination inside the module. The AC coupling is done inside the module and is not required on the host board. The inputs will accept differential swings of 40 – 1200 mV (20 – 600 mV single ended), though it is recommended that values between 50 and 900 mV differential (25 – 450 mV single ended) be used for best EMI performance.
8. RATE_SELECT is an input used to control transmitter and receiver compliance among multiple rates. It is internally pulled down with a 40kΩ resistor.

   Low (0 - 0.8V) or OPEN: Low Bit Rate Compliance (14.025Gb/s and 8.5 Gb/s)
   Between (0.8V and 2.0V): Undefined
   High (2.0 – Vcc max): High Bit Rate Compliance (28.05Gb/s)

Table 3. Absolute Maximum Ratings

Stress in excess of any of the individual Absolute Maximum Ratings can cause immediate catastrophic damage to the module even if all other parameters are within Recommended Operating Conditions. It should not be assumed that limiting values of more than one parameter can be applied to the module concurrently. Exposure to any of the Absolute Maximum Ratings for extended periods can adversely affect reliability.

Parameter	Symbol	Min.	Max.	Units	Reference
Storage Temperature	T_S	-40	85	°C	Note 1
Case Operating Temperature	T_C	-40	85	°C	
Relative Humidity	RH	5	95	%	
Supply Voltage	V_{CC}	-0.5	3.63	V	
Low Speed Input Voltage	Vi	-0.5	VCC+0.5, 3.63	V	

Table 4. Recommended Operating Conditions

Recommended Operating Conditions specify parameters for which the optical and electrical characteristics hold unless otherwise noted. Optical and electrical characteristics are not defined for operation outside the Recommended Operating Conditions, reliability is not implied and damage to the module may occur for such operation over an extended period of time.

Parameter	Symbol	Min.	Typ.	Max.	Units	Reference
Case Operating Temperature	Tc	0		70	°C	Note 2
Supply Voltage	V_{CC}	3.135	3.3	3.465	V	
Data Rate		8.5		28.05	Gb/s	Note 3
Two Wire Serial (TWS) Interface Clock Rate				400	kHz	Note 4

Table 5. Transceiver Electrical Characteristics

The following characteristics are defined over the Recommended Operating Conditions unless otherwise noted.

Parameter	Symbols	Min.	Typ.	Max.	Units	Reference
Transceiver Power Consumption				1.0	W	
Transceiver Power Supply Current				319	mA	
Power Supply Noise Tolerance (peak-peak)	PSNR			66	mVpp	Note 5
TX_FAULT, RX_LOS	I_{OH}	-50		37.5	µA	Note 6
	V_{OL}	-0.3		0.4	V	
TX_DIS, RS0, RS1	V_{IH}	2.0		Vcc+0.3	V	
	V_{IL}	-0.3		0.8	V	
MOD_SCL, MOD_SDA	V_{OH}	VCC_Hst-0.5		VCC_Hst+0.3	V	Note 7
	V_{OL}	0.0		0.4	V	
	V_{IH}	VccT*0.7		VccT+0.5	V	
	V_{IL}	-0.3		VccT*0.3	V	

Notes:

1. Absolute maximum ratings are those values beyond which damage to the device may occur if these limits are exceeded for other than a short period of time. See Reliability Data Sheet for specific reliability performance. Between Absolute Maximum Ratings and the Recommended Operating Conditions functional performance is not intended, device reliability is not implied, and damage to the device may occur over an extended period of time.
2. The position of case temperature measurement is shown in Figure 5. Continuous operation at the maximum Recommended Operating Case Temperature should be avoided in order not to degrade reliability.
3. 32GFC requires FEC RS(528,514) encoding per FC-PI-6. 16GFC and 8GFC are not compatible with FEC, per FC-PI-5.
4. With 500us clock stretch per SFF-8419
5. Filter per SFF-8419 specification is required on the host board.
6. Measured with a 4.7kΩ load pulled up to the host board to 3.3V
7. Mod_SCL and Mod_SDA must be pulled up externally with a 4.7k-10kΩ resistor on the host board to host VCC (3.14 < VCC_Hst < 3.46V).

Table 6. Transmitter and Receiver Electrical Characteristics

(Tc = 0°C to 70°C, VccT, VccR = 3.3V ± 5%)

Parameter	Symbol	Min.	Max.	Unit	Notes
High Speed Data Input Transmitter Differential Input Voltage (TD±)	V_I	50	900	mV	Note 1
High Speed Data Output Receiver Differential Output Voltage (RD ±)	V_O	250	900	mV	Note 2
Module Electrical Input, Differential Termination Resistance Mismatch			10	%	
Module Electrical Input Differential return loss SDD11					See FC-PI-6 Equation 6-1, Figure 10
Module Electrical Input Common Mode to Differential Conversion, SCD11					See FC-PI-6 Equation 6-2, Figure 12
Module Electrical Input, Differential Mode to Common Conversion, SDC11					See FC-PI-6 Equation 6-2, Figure 12
Module Electrical Input, Stressed Input Random Jitter, p-p, 10E-6 BER			0.09	UI	
Module Electrical Input, Stressed Input Eye Width at 1E-6 Probability EW6		0.46		UI	
Module Electrical Input, Stressed Input Eye Height at 1E-6 Probability EH6		50		mV	
Module Electrical Output, Common Mode Noise rms			17.5	mV,rms	
Module Electrical Output, Differential termination resistance mismatch			10	%	
Module Electrical Output, Differential return loss SDD22					See FC-PI-6 Equation 6-1, Figure 10
Module Electrical Output, Common Mode to Differential Conversion, SCD22					See FC-PI-6 Equation 6-3, Figure 12
Module Electrical Output, Differential Mode to Common Conversion, SDC22					See FC-PI-6 Equation 6-3, Figure 12
Module Electrical Output, Common Mode Return Loss, SCC22			-2	dB	
Module Electrical Output, Vertical Eye Closure			4	dB	
Module Electrical Output, Eye Width at 1E-6 Probability EW6		0.65		UI	
Module Electrical Output, Eye Height at 1E-6 Probability EH12		250		mV	
Receiver Total Jitter (28.05Gb/s)	TJ			UI	Compliance Test. Note 3, 5
Receiver Total Jitter (14.025Gb/s)	TJ		0.36	UI	Note 3,
Receiver Total Jitter (8.5Gb/s)	TJ		0.71	UI	Note 4,
Receiver Deterministic Jitter (14.025Gb/s)	DJ		0.22	UI	Note 3,
Receiver Deterministic Jitter (8.5Gb/s)	DJ		0.42	UI	Note 4,
Receiver Data Dependent Pulse Width Shrinkage (14.025Gb/s)	DDPWS		0.14	UI	Note 3,
Receiver Data Dependent Pulse Width Shrinkage (8.5Gb/s)	DDPWS		0.36	UI	Note 4,

Notes:

1. Internally ac coupled and terminated (100Ω differential).
2. Internally ac coupled but requires an external load termination (100Ω differential).
3. CDR is engaged with 28.05Gb/s and 14.025 Gb/s.
4. CDR is not engaged with 8.5 Gb/s.
5. 32GFC (28.05Gb/s) assumes a FEC encoded RS(528, 514) signal and allows a BER of 1E-6 for receiver and transmitter measurements.

Table 7. Transmitter Optical Characteristics

(Tc = 0°C to 70°C, VccT, VccR = 3.3V ± 5%)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Modulated Optical Output Power (OMA) (Peak to Peak) 28.05Gb/s	Tx,OMA	479			uW	
Modulated Optical Output Power (OMA) (Peak to Peak) 14.025Gb/s	Tx,OMA	331			uW	
Modulated Optical Output Power (OMA) (Peak to Peak) 8.5Gb/s	Tx,OMA	302			uW	
Average Optical Output Power 28.05Gb/s	Pout	-6.2			dBm	Note 1
Average Optical Output Power 14.025Gb/s	Pout	-7.8			dBm	Note 1
Average Optical Output Power 8.5Gb/s	Pout	-8.2			dBm	Note 1
Center Wavelength	λc	840		860	nm	
Spectral Width – rms	σrms			0.57	nm	
RIN12 (OMA)	RIN			-129	dB/Hz	
Optical Return Loss Tolerance				12	dB	
Vertical Eye Closure Penalty, 28.05Gb/s	VECP			3.13	dB	Note 2
Vertical Eye Closure Penalty, 14.025Gb/s	VECP			2.56	dB	Note 2
Transmitter Waveform Distortion Penalty, 8.5Gb/s	TWDP			4.3	dB	Note 3
Pout Tx_DISABLE Asserted	Poff			-35	dBm	

Notes:
1. Max Pout is the lesser of Class 1 safety limits (CDRH and EN 60825) or received power, max.
2. CDR is engaged with 28.05Gb/s and 14.025Gb/s.
3. CDR is not engaged with 8.5 Gb/s.

Table 8. Receiver Optical and Electrical Characteristics

(Tc = 0°C to 70°C, VccT, VccR = 3.3V ± 5%)

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Optical Input Power, 28.05 Gb/s	P_{IN}			+2	dBm,avg	
Optical Input Power, 14.025Gb/s and 8.5Gb/s	P_{IN}			0	dBm,avg	
Input Optical Modulation Amplitude, 28.05Gb/s (Peak to Peak) [Unstressed Sensitivity]	OMA	95			uW,OMA	Note 1, 5
Input Optical Modulation Amplitude, 14.025Gb/s (Peak to Peak) [Unstressed Sensitivity]	OMA	89			uW,OMA	Note 1
Input Optical Modulation Amplitude, 8.5Gb/s (Peak to Peak) [Unstressed Sensitivity]	OMA	76			uW,OMA	Note 1
Stressed Receiver Sensitivity (OMA) 28.05Gb/s		263			uW,OMA	Note 4, 5
Stressed Receiver Sensitivity (OMA) 14.025Gb/s		170			uW,OMA	Note 2
Stressed Receiver Sensitivity (OMA) 8.5Gb/s		151			uW,OMA	Note 3
Return Loss		12			dB	
Loss of Signal – Assert	Pa	-30			dBm,avg	
Loss of Signal – De-asserted	P_D			-9.1	dBm,avg	
Loss of Signal – Hysteresis	$P_A – P_D$	0.5			dB	

Notes:
1. Input Optical Modulation Amplitude (commonly known as sensitivity] requires a valid Fibre Channel encoded input.
2. 14.025 Gb/s stressed received vertical eye closure penalty (ISI) min is 2.5dB.
3. 8.5 Gb/s stressed received vertical eye closure penalty (ISI) min is 3.1dB.
4. 28.05 Gb/s stressed received vertical eye closure penalty (ISI) min is 3.1dB.
5. 32GFC (28.05Gb/s) assumes a FEC encoded RS(528, 514) signal and allows a BER of 1E-6 for receiver and transmitter measurements.

Table 9. Rate Select Definition

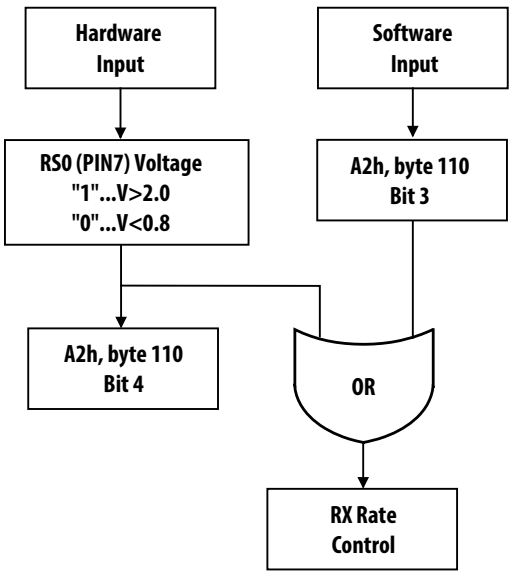
Function	State	Operation
Tx Rate Select RS(1)	High	Transmit Rate Select HIGH is defined for 32GFC operation. It configures the Tx CDR to lock on 28.05Gb/s 64b/66b encoded data, sets the Tx optical power and linear bandwidth for 32GFC operation. FEC is expected for 32GFC.
	Low	Transmit Rate Select LOW auto configures the internal Tx CDR for 16GFC (CDR locked) or 8GFC (CDR bypassed) operation. Transmit optical power and linear bandwidth are optimized accordingly. FEC is not expected for 16GFC or 8GFC. This is intended for use only with 16GFC and 8GFC traffic.
Rx Rate Select RS(0)	High	Receive Rate Select HIGH is defined for 32GFC operation. It configures the Rx CDR to lock on 28.05Gb/s 64b/66b encoded data, sets the Rx optical sensitivity and bandwidth for 32GFC operation. FEC is expected for 32GFC..
	Low	Receive Rate Select LOW auto configures the internal Rx CDR for 16GFC (CDR locked) or 8GFC (CDR bypassed) operation. Receiver optical sensitivity and linear bandwidth are optimized accordingly. FEC is not expected for 16GFC or 8GFC. This is intended for use only with 16GFC and 8GFC traffic.

Note: During Fibre Channel Link Speed Negotiation sequences, the host will control Tx Rate and Rx Rate inputs separately to accomplish link initialization. Once speed negotiation is complete, it is expected both Tx Rate and Rx Rate will be placed in the same state by the host.

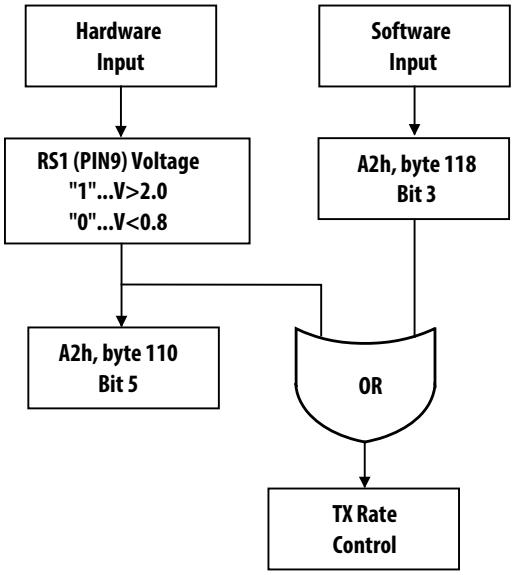
Rate Select Control

RX and TX rates can be independently controlled by either hardware input pins or via register writes. Module electrical input pins 7 and 9 are used to select RX and TX rate respectively. Status of each logic level is reflected to register byte 110 bit 4 and 5 on address A2h as shown in the diagram below. RX and TX rates can also be controlled via register writes to bytes 110 bit 3 and 118 bit 3. Power on default of these bits are logic low. Hardware and software control inputs are OR'd to allow flexible control.

RS0 RX Rate Select control flow



RS1 TX Rate Select control flow



RS0 Control Input		RX Operation	
Hardware	Software		
0	0	16G/8G FC	Rx CDR auto detect
0	1	32GFC	Rx CDR engaged
1	0	32GFC	Rx CDR engaged
1	1	32GFC	Rx CDR engaged

RS1 Control Input		TX Operation	
Hardware	Software		
0	0	16G/8G FC	Tx CDR auto detect
0	1	32GFC	Tx CDR engaged
1	0	32GFC	Tx CDR engaged
1	1	32GFC	Tx CDR engaged

Table 10. Transceiver SOFT DIAGNOSTIC Timing Characteristics

(T_C = 0°C to 70°C, VccT, VccR = 3.3V ± 5%)

Parameter	Symbol	Minimum	Maximum	Unit	Notes
Hardware TX_DISABLE Assert Time	t_off		100	µs	Note 1
Hardware TX_DISABLE Negate Time	t_on		2	ms	Note 2
Time to initialize, including reset of TX_FAULT	t_init		300	ms	Note 3
Hardware TX_FAULT Assert Time	t_fault		1	ms	Note 4
Hardware TX_DISABLE to Reset	t_reset	10		µs	Note 5
Hardware RX_LOS DeAssert Time	t_loss_on		100	µs	Note 6
Hardware RX_LOS Assert Time	t_loss_off		100	µs	Note 7
Hardware RATE_SELECT Assert Time	t_rate_high		2	ms	Note 8
Hardware RATE_SELECT DeAssert Time	t_rate_low		2	ms	Note 8
Software TX_DISABLE Assert Time	t_off_soft		100	ms	Note 9
Software TX_DISABLE Negate Time	t_on_soft		100	ms	Note 10
Software Tx_FAULT Assert Time	t_fault_soft		100	ms	Note 11
Software Rx_LOS Assert Time	t_loss_on_soft		100	ms	Note 12
Software Rx_LOS De-Assert Time	t_loss_off_soft		100	ms	Note 13
Software RATE_SELECT Assert Time	t_rate_soft_high		100	ms	Note 14
Software RATE_SELECT DeAssert Time	t_rate_soft_low		100	ms	Note 15
Analog parameter data ready	t_data		1000	ms	Note 16
Serial bus hardware ready	t_serial		300	ms	Note 17
Serial bus buffer time	t_buf	20		µs	Note 18
Complete Single or Sequential Write up to 4 Byte	twR		40	ms	Note 19
Complete Sequential Write of 5-8 Byte	twR		80	ms	
Serial Interface Clock Holdoff "Clock Stretching"	T_clock_hold		500	µs	Note 20
Serial ID Clock Rate	f_serial_clock		400	kHz	Note 21

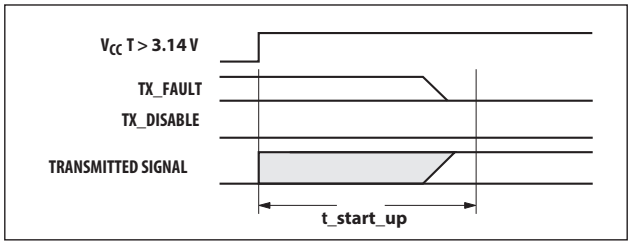
Notes

1. Time from rising edge of TX_DISABLE to when the optical output falls below 10% of nominal.
2. Time from falling edge of TX_DISABLE to when the modulated optical output rises above 90% of nominal.
3. Time from power on or falling edge of Tx_Disable to when the modulated optical output rises above 90% of nominal.
4. From occurrence of fault to assertion of TX_FAULT.
5. Time TX_DISABLE must be held high to reset the laser fault shutdown circuitry.
6. Time from loss of optical signal to Rx_LOS Assertion.
7. Time from valid optical signal to Rx_LOS De-Assertion.
8. Time from rising or falling edge of Rate_Select input until transceiver is successfully passing traffic as designated by RS(0) and RS(1). For Rate_Se-lect going high, the internal CDR will lock on valid 32GFC encoded data within the specified time. For Rate_Select going low, the internal CDR will attempt to lock on valid 16GFC encoded data for a certain gating period. If valid 16GFC data is not detected in that gating period, the inter-nal CDR will automatically be bypassed for use at 8GFC rates.
9. Time from two-wire interface assertion of TX_DISABLE (A2h, byte 110, bit 6) to when the optical output falls below 10% of nominal. Measured from falling clock edge after stop bit of write transaction.
10. Time from two-wire interface de-assertion of TX_DISABLE (A2h, byte 110, bit 6) to when the optical output rises above 90% of nominal.
11. Time from fault to two-wire interface TX_FAULT (A2h, byte 110, bit 2) asserted.
12. Time for two-wire interface assertion of Rx_LOS (A2h, byte 110, bit 1) from loss of optical signal.
13. Time for two-wire interface de-assertion of Rx_LOS (A2h, byte 110, bit 1) from presence of valid optical signal.
14. Time from two-wire interface Assertion of Rate_Select (either RS(0) in A2h, byte 110, bit 3 or RS(1) in A2h, byte 118, bit 3) to when the respective CDR is engaged at 32GCFC data rate.
15. Time from two-wire interface De-Assertion of Rate_Select (either RS(0) in A2h, byte 110, bit 3 or RS(1) in A2h, byte 118, bit 3) to when the respective CDR is either engaged at 16GFC data rate or bypassed for 8GFC operation.
16. From power on to data ready bit asserted (A2h, byte 110, bit 0). Data ready indicates analog monitoring circuitry is functional.
17. Time from power on until module is ready for data transmission over the serial bus (reads or writes over A0h and A2h).
18. Time between START and STOP commands.
19. Time from stop bit to completion of a 1-8 byte write command.
20. Maximum time the SFP+ module may hold the SCL line low before continuing with a read or write operation.
21. With a maximum Clock Stretch of 500us. A maximum of 100kHz operation can be supported without a Clock Stretch.

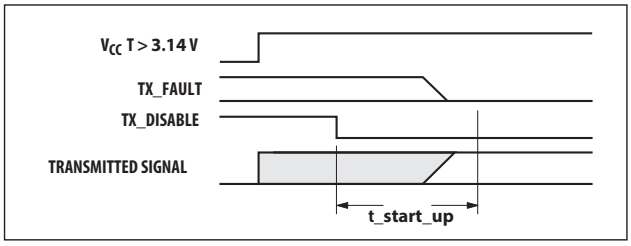
Table 11. Transceiver Digital Diagnostic Monitor (Real Time Sense) Characteristics

(T_C = 0°C to 70°C, VccT, VccR = 3.3V ± 5%)

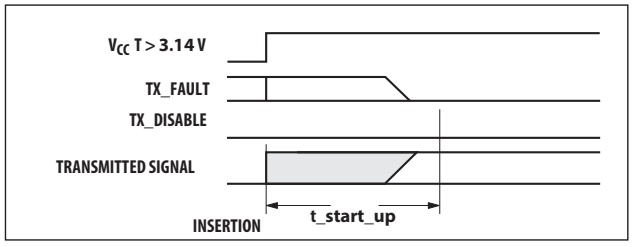
Parameter	Symbol	Min.	Units	Notes
Transceiver Internal Temperature Accuracy	T_{INT}	± 3.0	°C	Temperature is measured internal to the transceiver. Valid from = 0°C to 70 °C case temperature.
Transceiver Internal Supply Voltage Accuracy	V_{INT}	± 0.1	V	Supply voltage is measured internal to the transceiver and can, with less accuracy, be correlated to voltage at the SFP Vcc pin. Valid over 3.3 V ± 5%.
Transmitter Laser DC Bias Current Accuracy	I_{INT}	± 10	%	I_{INT} is better than ±10% of the nominal value.
Transmitted Average Optical Output Power Accuracy	P_T	± 3.0	dB	Coupled into 50um multi-mode fiber. Valid from -8.2dBm to +2dBm avg.
Received Optical Input Power Accuracy	P_R	± 3.0	dB	Coupled from 50um multi-mode fiber. Valid from -10.3dBm to +2dBm avg.



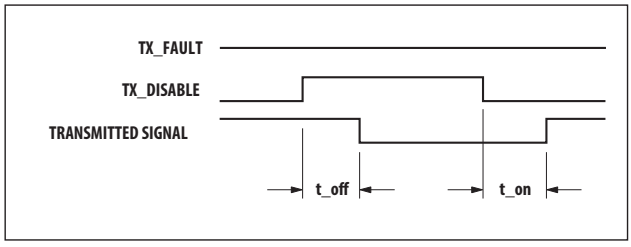
t_start_up: TX DISABLE NEGATED



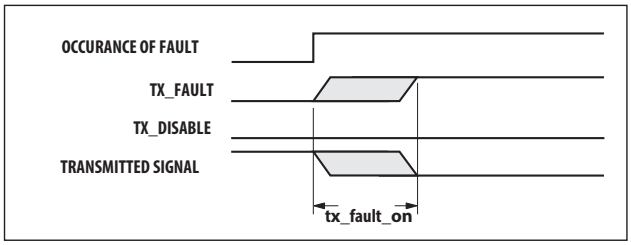
t_start_up: TX DISABLE ASSERTED



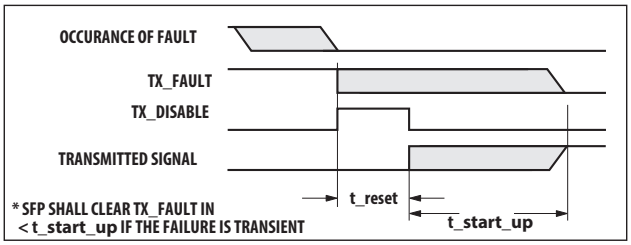
t_start_upt: TX DISABLE NEGATED, MODULE HOT PLUGGED



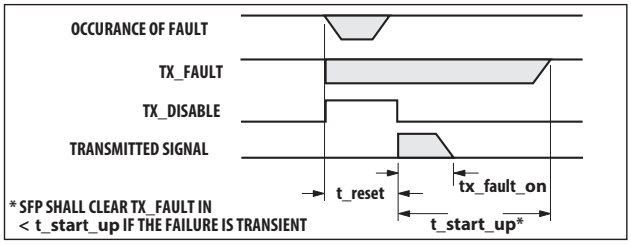
t-off & t-on: TX DISABLE ASSERTED THEN NEGATED



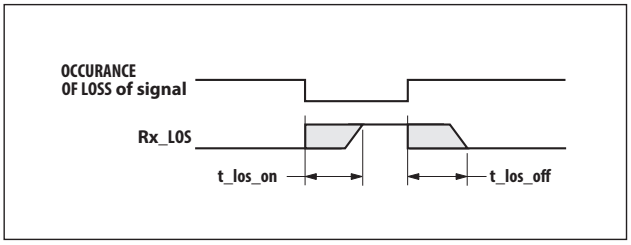
tx_fault_on: TX FAULT ASSERTED, TX SIGNAL NOT RECOVERED



t_reset: TX DISABLE ASSERTED THEN NEGATED, TX SIGNAL RECOVERED



tx_fault_on: TX DISABLE ASSERTED THEN NEGATED, TX SIGNAL NOT RECOVERED



t_los_on & t_los_off

Figure 4. Transceiver timing diagrams (module installed except where noted)

Table 12. EEPROM Serial ID Memory Contents – Address A0h

Byte # Decimal	Hex	Description	Byte # Decimal	Hex	Description
0	03	SFP physical device	38	17	Hex Byte of Vendor OUI [4]
1	04	SFP function defined by serial ID only	39	6A	Hex Byte of Vendor OUI [4]
2	07	LC optical connector	40	41	"A" - Vendor Part Number ASCII Character
3	00		41	46	"F" - Vendor Part Number ASCII Character
4	00		42	42	"B" - Vendor Part Number ASCII Character
5	00		43	52	"R" - Vendor Part Number ASCII Character
6	00		44	2D	"-" - Vendor Part Number ASCII Character
7	60	Short and Intermediate link distance (per FC-PI-6)	45	35	"5" - Vendor Part Number ASCII Character
8	40	Shortwave laser without OFC (open fiber control)	46	37	"7" - Vendor Part Number ASCII Character
9	04	Multi-mode 50um optical media	47	47	"G" - Vendor Part Number ASCII Character
10	68	800, 1600 & 3200 MBytes/sec FC-PI-6 speed [1]	48	35	"5" - Vendor Part Number ASCII Character
11	06	64B/66B data at 32GFC/16GFC & 8B/10B at 8GFC	49	4D	"M" - Vendor Part Number ASCII Character
12	FF	Greater than 25.5Gb/s (See Address 66)	50	5A	"Z" - Vendor Part Number ASCII Character
13	0C	Rate Select (High=32GFC, Low=16GFC, 8GFC)	51	20	" " - Vendor Part Number ASCII Character
14	00		52	20	" " - Vendor Part Number ASCII Character
15	00		53	20	" " - Vendor Part Number ASCII Character
16	02	20m of OM2 50/125um distance at 32GFC [2]	54	20	" " - Vendor Part Number ASCII Character
17	00	Unspecified OM1 62.5/125um distance at 32GFC [3]	55	20	" " - Vendor Part Number ASCII Character
18	0A	100m of OM4 50/125um fiber at 32GFC [10]	56	20	" " - Vendor Revision ASCII Character
19	07	70m of OM3 50/125um fiber at 32GFC [9]	57	20	" " - Vendor Revision ASCII Character
20	41	"A" - Vendor Name ASCII Character	58	20	" " - Vendor Revision ASCII Character
21	56	"V" - Vendor Name ASCII Character	59	20	" " - Vendor Revision ASCII Character
22	41	"A" - Vendor Name ASCII Character	60	03	Hex Byte of Laser Wavelength [5]
23	47	"G" - Vendor Name ASCII Character	61	52	Hex Byte of Laser Wavelength [5]
24	4F	"O" - Vendor Name ASCII Character	62	00	
25	20	" " - Vendor Name ASCII Character	63		Checksum for Bytes 0-62 [6]
26	20	" " - Vendor Name ASCII Character	64	08	CDRs present. 1W power class
27	20	" " - Vendor Name ASCII Character	65	3A	Hardware Tx_Disable, Tx_Fault, Rx_LOS, Rate_Select
28	20	" " - Vendor Name ASCII Character	66	70	28.050 Gbit/sec nominal bit rate (32GFC)
29	20	" " - Vendor Name ASCII Character	67	00	
30	20	" " - Vendor Name ASCII Character	68 - 83		Vendor Serial Number ASCII characters [7]
31	20	" " - Vendor Name ASCII Character	84 - 91		Vendor Date Code ASCII characters [8]
32	20	" " - Vendor Name ASCII Character	92	68	Digital diagnostics, Internal Cal, Rx Pwr Avg
33	20	" " - Vendor Name ASCII Character	93	FA	Alarms/Warnings, Software Tx_Disable, Tx-Fault, Rx_LOS, Rate_Select
34	20	" " - Vendor Name ASCII Character	94	08	SFF-8472 compliance to revision 12.2
35	20	" " - Vendor Name ASCII Character	95		Checksum for Bytes 62-94 [6]
36	00		96 – 255	00	
37	00	Hex Byte of Vendor OUI [4]			

Notes:

1. FC-PI-6 speed 3200 MBytes/sec is a serial bit rate of 28.05Gb/s using FEC encoded data (RS 528/514). FC-PI-5 speed 1600 MBytes/sec is a serial bit rate of 14.025Gb/s. 800 MBytes/sec is a serial bit rate of 8.5Gb/s.
2. Link distance with OM2 50/125um cable at 16GFC is 35m and at 8GFC is 50m.
3. Link distance with OM1 62.5/125um cable at 8.5Gb/s is 25m (and is unspecified at 16GFC).
4. The IEEE Organizationally Unique Identified (OUI) assigned to Avago Technologies is 00-17-6A (3 bytes of hex).
5. Laser Wavelength is represented in 16 unsigned bits. The hex representation of 850nm is 0352.
6. Addresses 63 and 95 are checksums calculated (per SFF-8472 and SFF-8074) and stored prior to product shipment.
7. Address 68-83 specify the AFBR-57G5MZ ASCII serial number and will vary on a per unit basis.
8. Address 84-91 specify the AFBR-57G5MZ ASCII date code and will vary on a per date code basis.
9. Link distance with OM3 50/125um cable at 16GFC is 100m and at 8GFC is 150m..
10. Link distance with OM4 50/125um cable at 16GFC is 125m and at 8GFC is 190m.

Table 13. EEPROM Serial ID Memory Contents - Enhanced SFP Memory (Address A2h)

Byte # Decimal	Notes	Byte # Decimal	Notes	Byte # Decimal	Notes
0	Temp H Alarm MSB [1]	26	Tx Power L Alarm MSB [4]	104	Real Time Rx Power MSB [5]
1	Temp H Alarm LSB [1]	27	Tx Power L Alarm LSB [4]	105	Real Time Rx Power LSB [5]
2	Temp L Alarm MSB [1]	28	Tx Power H Warning MSB [4]	106	Reserved
3	Temp L Alarm LSB [1]	29	Tx Power H Warning LSB [4]	107	Reserved
4	Temp H Warning MSB [1]	30	Tx Power L Warning MSB [4]	108	Reserved
5	Temp H Warning LSB [1]	31	Tx Power L Warning LSB [4]	109	Reserved
6	Temp L Warning MSB [1]	32	Rx Power H Alarm MSB [5]	110	Status/Control – See Table 14
7	Temp L Warning LSB [1]	33	Rx Power H Alarm LSB [5]	111	Status/Control – See Table 15
8	Vcc H Alarm MSB [2]	34	Rx Power L Alarm MSB [5]	112	Flag Bits – See Table 16
9	Vcc H Alarm LSB [2]	35	Rx Power L Alarm LSB [5]	113	Flag Bits – See Table 16
10	Vcc L Alarm MSB [2]	36	Rx Power H Warning MSB [5]	114	Tx Input EQ Control - See Table 19, 20
11	Vcc L Alarm LSB [2]	37	Rx Power H Warning LSB [5]	115	Rx Output Emphasis Control - See Table 21, 22
12	Vcc H Warning MSB [2]	38	Rx Power L Warning MSB [5]	116	Flag Bits – See Table 16
13	Vcc H Warning LSB [2]	39	Rx Power L Warning LSB [5]	117	Flag Bits – See Table 16
14	Vcc L Warning MSB [2]	40-55	Control Settings – See Table 18	118	Status/Control – See Table 17
15	Vcc L Warning LSB [2]	56-94	External Calibration Constants [6]	119	CDR Loss of Lock Status - See Table 18
16	Tx Bias H Alarm MSB[3]	95	Checksum for Bytes 0-94 [7]	120-126	Reserved
17	Tx Bias H Alarm LSB[3]	96	Real Time Temperature MSB [1]	127	Page Select Control
18	Tx Bias L Alarm MSB [3]	97	Real Time Temperature LSB [1]	128-247	Customer Writable
19	Tx Bias L Alarm LSB[3]	98	Real Time Vcc MSB [2]	248-255	Vendor Specific
20	Tx Bias H Warning MSB[3]	99	Real Time Vcc LSB [2]		
21	Tx Bias H Warning LSB[3]	100	Real Time Tx Bias MSB [3]		
22	Tx Bias L Warning MSB [3]	101	Real Time Tx Bias LSB [3]		
23	Tx Bias L Warning LSB[3]	102	Real Time Tx Power MSB [4]		
24	Tx Power H Alarm MSB [4]	103	Real Time Tx Power LSB [4]		
25	Tx Power H Alarm LSB [4]				

Notes:

1. Temperature (Temp) is decoded as a 16 bit signed two's complement integer in increments of 1/256 °C.
2. Supply Voltage (Vcc) is decoded as a 16 bit unsigned integer in increments of 100 μV.
3. Tx bias current (Tx Bias) is decoded as a 16 bit unsigned integer in increments of 2 μA.
4. Transmitted average optical power (Tx Pwr) is decoded as a 16 bit unsigned integer in increments of 0.1 μW.
5. Received average optical power (Rx Pwr) is decoded as a 16 bit unsigned integer in increments of 0.1 μW.
6. Bytes 56-94 are not intended for use, but have been set to default values per SFF-8472.
7. Byte 95 is a checksum calculated (per SFF-8472) and stored prior to product shipment.

Table 14. EEPROM Serial ID Memory Contents – Soft Commands (Address A2h, Byte 110).

Bit #	Status/Control Name	Description	Notes
7	TX_DISABLE State	Digital state of TX_DISABLE Input Pin (1 = TX_DISABLE asserted)	Note 1
6	Soft TX_DISABLE Control	Read/write bit for changing digital state of TX_DISABLE function	Note 1, 2
5	RS(1) State	Digital state of TX Rate_Select Input Pin RS(1) (1 = Rate High asserted)	
4	RS(0) State	Digital state of RX Rate_Select Input Pin RS(0) (1 = Rate High asserted)	
3	Soft RS(0) Control	Read/write bit for changing digital state of Rx Rate_Select RS(0) function	Note 3
2	TX_FAULT State	Digital state of TX_FAULT Output Pin (1 = TX_FAULT asserted)	Note 1
1	RX_LOS State	Digital state of SFP RX_LOS Output Pin (1 = RX_LOS asserted)	Note 1
0	Data Ready (Bar)	Indicates transceiver is powered and real time sense data is ready (0 = Data Ready)	

Notes:
1. The response time for soft commands of the AFBR-57G5MZ is 100msec as specified by MSA SFF-8472.
2. Bit 6 is logic OR'd with the SFP TX_DISABLE input pin 3 …. either asserted will disable the SFP transmitter.
3. Bit 3 is logic OR'd with the SFP RS(0) RX Rate_Select input pin 7 …. either asserted will set receiver to Rate = High.

Table 15. EEPROM Serial ID Memory Contents – Soft Commands (Address A2h, Byte 111).

Bit #	Status/Control Name	Description	Notes
3-7	Reserved		
2	OWRAP Control Bit	Logic Low = OWRAP disabled. Logic High = OWRAP enabled. When enabled, OWRAP routes incoming SFP Rx optical data to the Tx optical output and Rx electrical output. Enabling clears all other bits in byte 111.	
1	EWRAP FORWARD Control Bit	Logic Low = FORWARD disabled. Logic High = FORWARD enabled. When used in combination with EWRAP enable, FORWARD routes incoming SFP Tx electrical data to both Rx electrical output and Tx optical output. Enabling sets bit 0 and clears all other bits in byte 111.	
0	EWRAP Control Bit	Logic Low = EWRAP disabled. Logic High = EWRAP enabled. When enabled, EWRAP routes incoming SFP Tx electrical data to the Rx electrical output. Enabling clears all other bits in byte 111.	

Table 16. EEPROM Serial ID Memory Contents – Alarms and Warnings (Address A2h, Bytes 112, 113, 116, 117)

Byte	Bit	Flag Bit Name	Description
112	7	Temp High Alarm	Set when transceiver internal temperature exceeds high alarm threshold.
	6	Temp Low Alarm	Set when transceiver internal temperature exceeds low alarm threshold.
	5	Vcc High Alarm	Set when transceiver internal supply voltage exceeds high alarm threshold.
	4	Vcc Low Alarm	Set when transceiver internal supply voltage exceeds low alarm threshold.
	3	Tx Bias High Alarm	Set when transceiver laser bias current exceeds high alarm threshold.
	2	Tx Bias Low Alarm	Set when transceiver laser bias current exceeds low alarm threshold.
	1	Tx Power High Alarm	Set when transmitted average optical power exceeds high alarm threshold.
	0	Tx Power Low Alarm	Set when transmitted average optical power exceeds low alarm threshold.
113	7	Rx Power High Alarm	Set when received average optical power exceeds high alarm threshold.
	6	Rx Power Low Alarm	Set when received average optical power exceeds low alarm threshold.
	0-5	reserved	
116	7	Temp High Warning	Set when transceiver internal temperature exceeds high warning threshold.
	6	Temp Low Warning	Set when transceiver internal temperature exceeds low warning threshold.
	5	Vcc High Warning	Set when transceiver internal supply voltage exceeds high warning threshold.
	4	Vcc Low Warning	Set when transceiver internal supply voltage exceeds low warning threshold.
	3	Tx Bias High Warning	Set when transceiver laser bias current exceeds high warning threshold.
	2	Tx Bias Low Warning	Set when transceiver laser bias current exceeds low warning threshold.
	1	Tx Power High Warning	Set when transmitted average optical power exceeds high warning threshold.
	0	Tx Power Low Warning	Set when transmitted average optical power exceeds low warning threshold.
117	7	Rx Power High Warning	Set when received average optical power exceeds high warning threshold.
	6	Rx Power Low Warning	Set when received average optical power exceeds low warning threshold.
	0-5	reserved	

Table 17. EEPROM Serial ID Memory Contents – Soft Commands (Address A2h, Byte 118).

Bit #	Status/Control Name	Description	Notes
4-7	Reserved		
3	Soft RS(1) Control	Read/write bit for changing digital state of Tx Rate_Select RS(1) function	Note 1
2	Reserved		
1	Power Level State	Always set to zero. Value of zero indicates Power Level 1 operation (1 Watt max)	
0	Power Level Select	Unused. This device supports power level zero (1 Watt max) only.	

Notes:
1. Bit 3 is log OR'd with the SFP RS(1) TX Rate_Select input pin 9 …. either asserted will set transmitter to Rate = High.

Table 18. EEPROM Serial ID Memory Contents – CDR Loss of Lock (LOL) Status Indicators (Address A2h, Byte 119).

Bit #	Status/Control Name	Description	Notes
7-2	Reserved		
1	Tx CDR LOL Flag	A value of 0 indicates the CDR is locked. A value of 1 indicates CDR loss of lock. If the CDR is operationally bypassed (ie. for 8.5Gb/s operation), value is undefined.	
0	Rx CDR LOL Flag	A value of 0 indicates the CDR is locked. A value of 1 indicates CDR loss of lock. If the CDR is operationally bypassed (ie. for 8.5Gb/s operation), value is undefined.	

Table 19. EEPROM Serial ID Memory Contents – Transmitter Input Electrical Equalization Control (Address A2h, Byte 114).

Bit #	Status/Control Name	Description
7-4	TX EQ, RS(1)=HIGH	Selects an input equalization value per Table 9-13 of SFF-8472 for high rate operation.
3-0	TX EQ, RS(1)=LOW	Selects an input equalization value per Table 9-13 of SFF-8472 for low rate operation.

Table 20. Transmitter Input Equalization Control Values (Address A2h, Byte 114)

From Table 9-13 of SFF-8472

	Transmitter Input Equalization	
Code	**Nominal**	**Units**
11xx	Reserved	
1011	Reserved	
1010	10	dB
1001	9	dB
1000	8	dB
0111	7	dB
0110	6	dB
0101	5	dB
0100	4	dB
0011	3	dB
0010	2	dB
0001	1	dB
0000	0	No Equalization

Table 21. EEPROM Serial ID Memory Contents – Receiver Output Electrical Emphasis Control (Address A2h, Byte 115).

Bit #	Status/Control Name	Description
7-4	RX EMPH, RS(0)=HIGH	Selects an output emphasis value per Table 9-14 of SFF-8472 for high rate operation.
3-0	RX EMPH, RS(0)=LOW	Selects an output emphasis value per Table 9-14 of SFF-8472 for low rate operation.

Table 22. Receiver Output Emphasis Control Values (Address A2h, Byte 115)

From Table 9-14 of SFF-8472

	Receiver Output Emphasis At nominal Output Amplitude	
Code	**Nominal**	**Units**
1xxx	Vendor Specific	
0111	7	dB
0110	6	dB
0101	5	dB
0100	4	dB
0011	3	dB
0010	2	dB
0001	1	dB
0000	0	No Emphasis

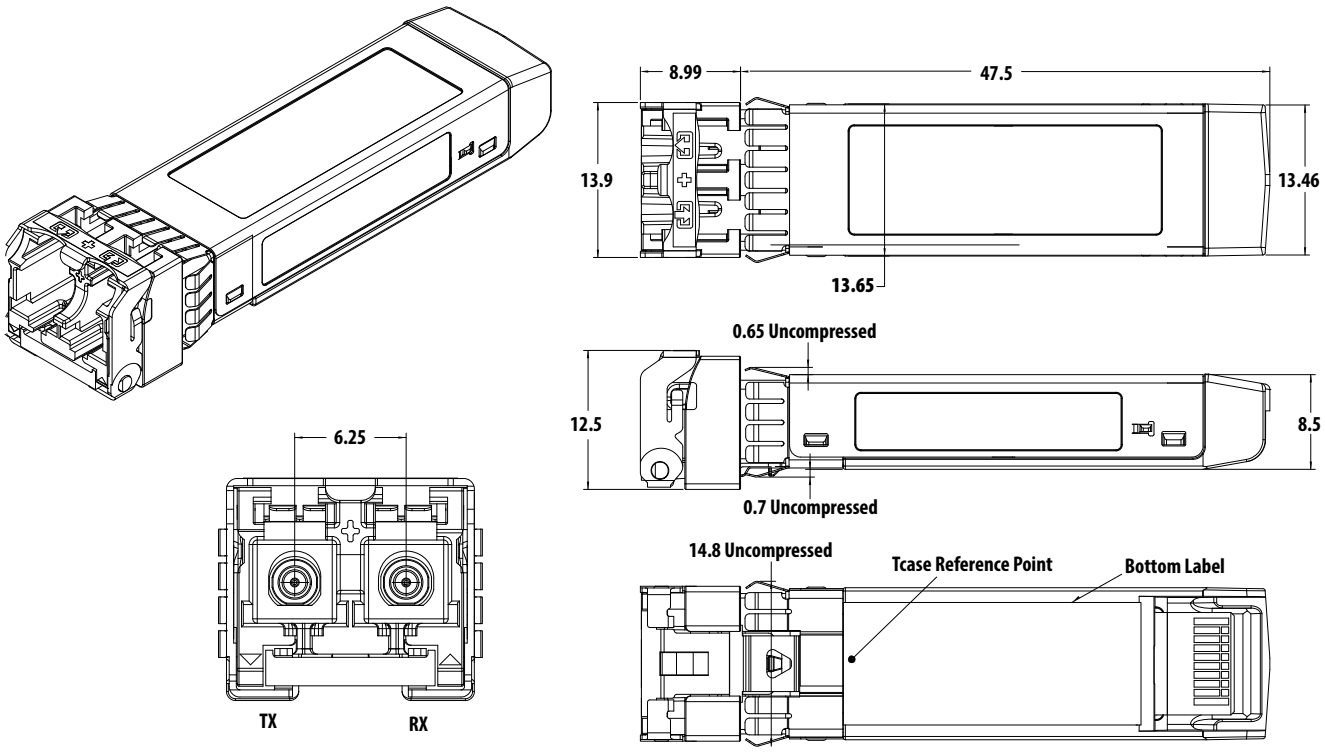
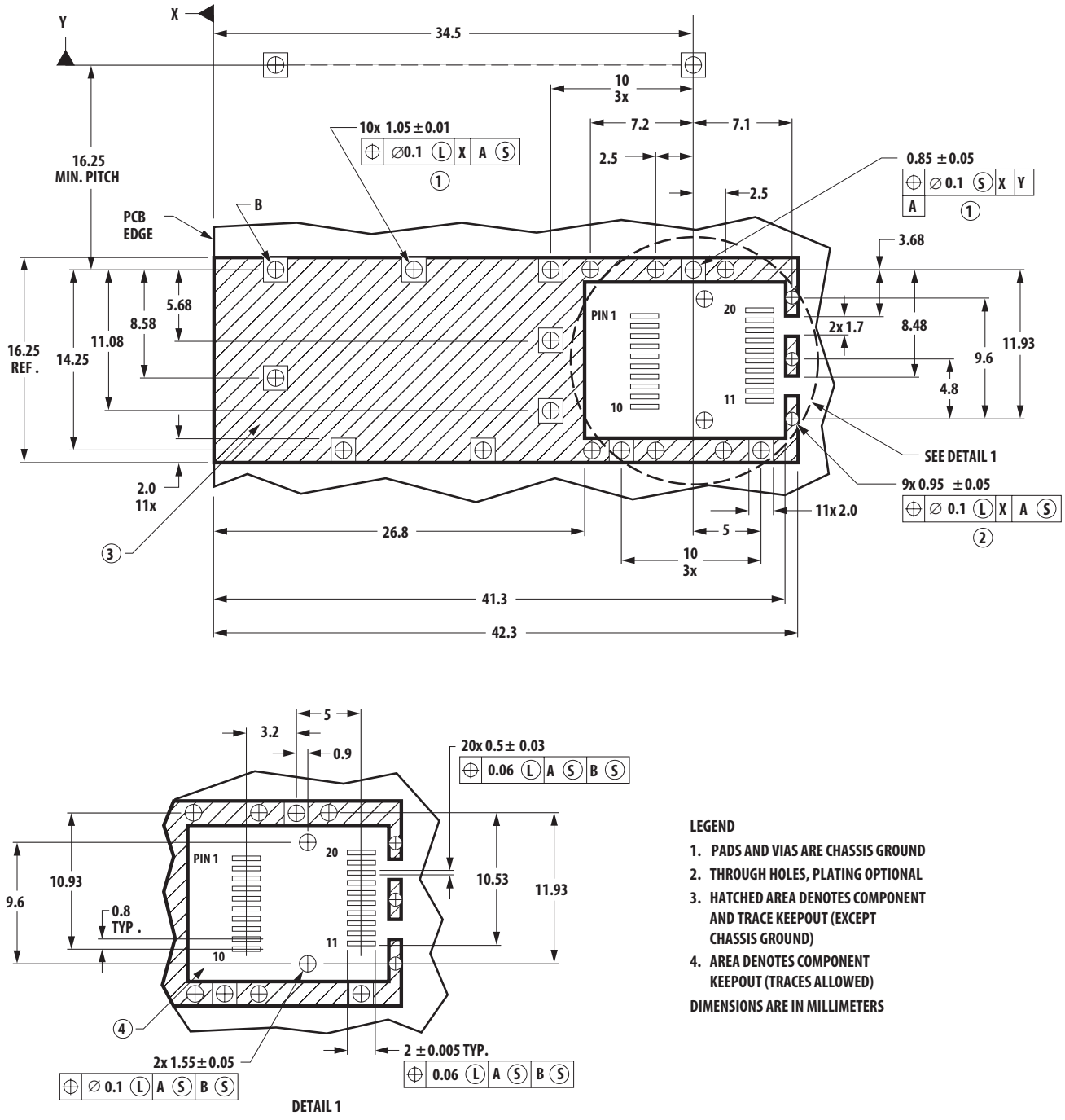


Figure 5. Module drawing

Figure 6. Module Label



LEGEND

1. PADS AND VIAS ARE CHASSIS GROUND
2. THROUGH HOLES, PLATING OPTIONAL
3. HATCHED AREA DENOTES COMPONENT AND TRACE KEEPOUT (EXCEPT CHASSIS GROUND)
4. AREA DENOTES COMPONENT KEEPOUT (TRACES ALLOWED)

DIMENSIONS ARE IN MILLIMETERS

Figure 7. SFP host board mechanical layout

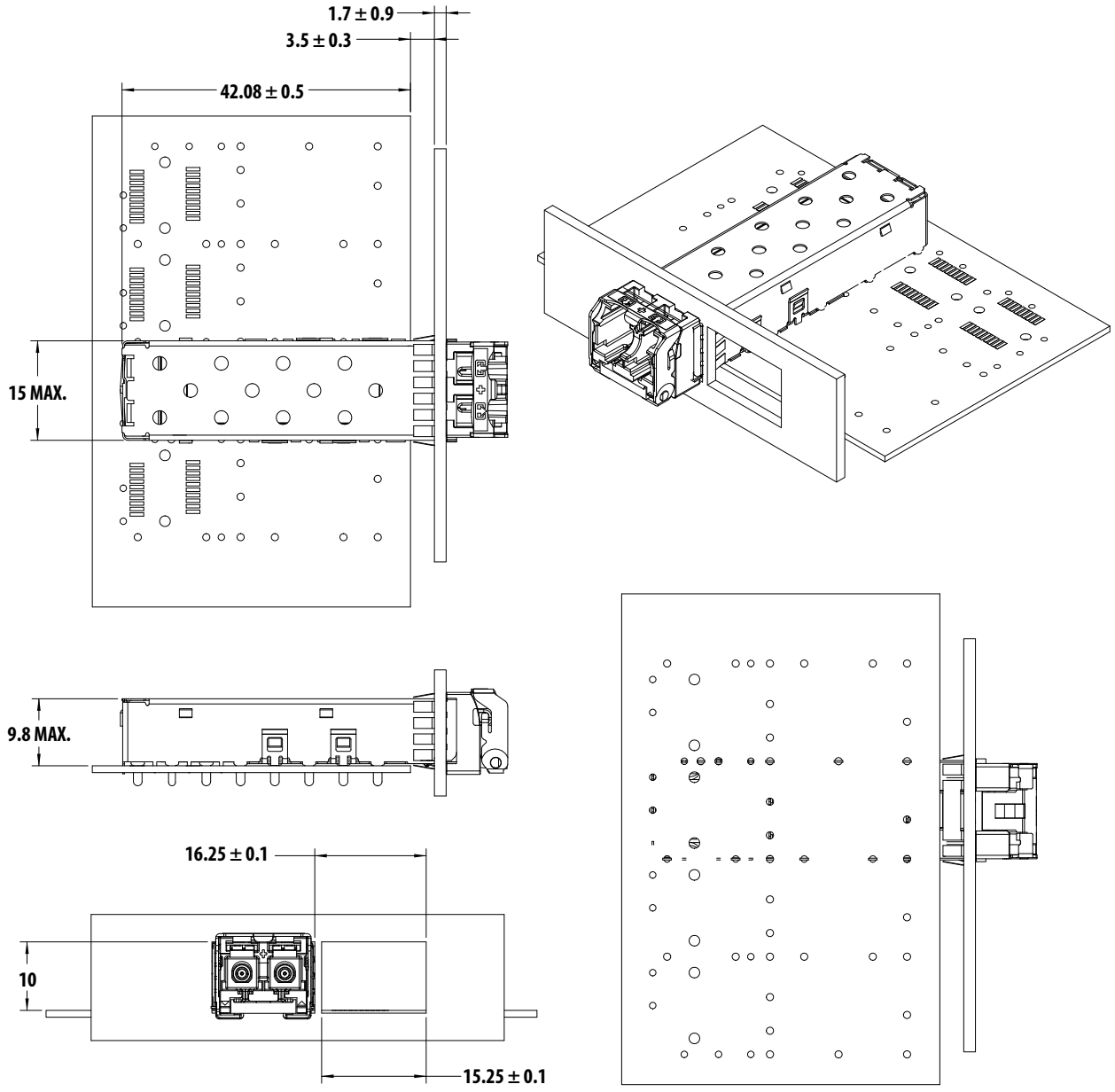


Figure 8. SFP Assembly drawing

Customer Manufacturing Processes

This module is pluggable and is not designed for aqueous wash, IR reflow, or wave soldering processes.

For product information and a complete list of distributors, please go to our website: **www.avagotech.com**

pub-005170 - **October** 19,2016